RENESAS

R1LP0108E Series

1Mb Advanced LPSRAM (128k word x 8bit)

R10DS0151EJ0100 Rev.1.00 2013.6.21

Description

The R1LP0108E Series is a family of low voltage 1-Mbit static RAMs organized as 131,072-word by 8-bit, fabricated by Renesas's high-performance 0.15um CMOS and TFT technologies. The R1LP0108E Series has realized higher density, higher performance and low power consumption. The R1LP0108E Series is suitable for memory applications where a simple interfacing, battery operating and battery backup are the important design objectives. It has been packaged in 32-pin SOP, 32-pin TSOP and 32-pin sTSOP.

Features

- Single 4.5~5.5V power supply
- Small stand-by current: 0.6µA (5.0V, typical)
- No clocks, No refresh
- All inputs and outputs are TTL compatible.
- Easy memory expansion by CS1# and CS2
- Common Data I/O
- Three-state outputs: OR-tie Capability
- OE# prevents data contention on the I/O bus



Ordering Information

Orderable Part Name	Access time	Temperature Range	Package	Shipping Container	Quantity	
R1LP0108ESN-5SR#B*	55 00	0 ~ +70°C				
R1LP0108ESN-5SI#B*	55 ns	-40 ~ +85°C		Tube	Max. 25pcs/Tube	
R1LP0108ESN-7SR#B*	70 ns	0 ~ +70°C	525-mil 32-pin	Tube	Max. 225pcs/Inner Bag Max. 900pcs/Inner Box	
R1LP0108ESN-7SI#B*	70115	-40 ~ +85°C	plastic SOP			
R1LP0108ESN-5SR#S*	EE no	0 ~ +70°C	PRSP0032DF-A			
R1LP0108ESN-5SI#S*	55 ns	-40 ~ +85°C	(32P2S-A)	Embossed		
R1LP0108ESN-7SR#S*	70 ns	0 ~ +70°C		tape	1000pcs/Reel	
R1LP0108ESN-7SI#S*	70115	-40 ~ +85°C				
R1LP0108ESA-5SR#B*	55 ns	0 ~ +70°C				
R1LP0108ESA-5SI#B*	55 115	-40 ~ +85°C		Trov	Max. 234pcs/Tray	
R1LP0108ESA-7SR#B*	70 ns	0 ~ +70°C	8mm×13.4mm 32-pin plastic sTSOP	Tray	Max. 1872pcs/Inner Box	
R1LP0108ESA-7SI#B*	70115	-40 ~ +85°C	(normal-bend type)			
R1LP0108ESA-5SR#S*	55 ns	0 ~ +70°C				
R1LP0108ESA-5SI#S*	55 115	-40 ~ +85°C	PTSA0032KB-A (32P3K-B)	Embossed		
R1LP0108ESA-7SR#S*	70 ==	0 ~ +70°C		tape	1000pcs/Reel	
R1LP0108ESA-7SI#S*	70 ns	-40 ~ +85°C				
R1LP0108ESF-5SR#B*	55	0 ~ +70°C				
R1LP0108ESF-5SI#B*	55 ns	-40 ~ +85°C		Tasu	Max. 156pcs/Tray	
R1LP0108ESF-7SR#B*	70 ==	0 ~ +70°C	8mm×20mm 32-pin plastic TSOP	Tray	Max. 1248pcs/Inner Box	
R1LP0108ESF-7SI#B*	70 ns	-40 ~ +85°C	(normal-bend type)			
R1LP0108ESF-5SR#S*	FF 	0 ~ +70°C				
R1LP0108ESF-5SI#S*	55 ns	-40 ~ +85°C	PTSA0032KA-A (32P3H-E)	Embossed	1000nee/Deel	
R1LP0108ESF-7SR#S*	70	0 ~ +70°C		tape	1000pcs/Reel	
R1LP0108ESF-7SI#S*	70 ns	-40 ~ +85°C				

Pin Arrangement

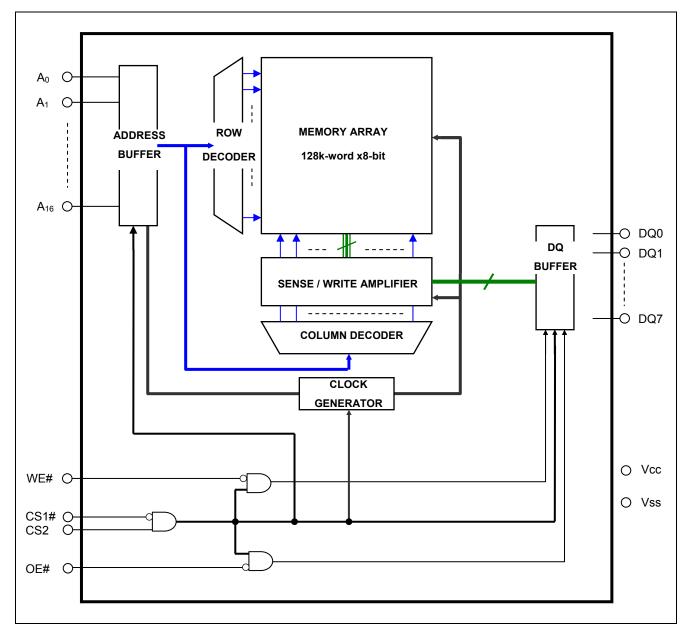
NC 32 Vcc A16 31 A15 2 CS2 A14 30 3 WE# A12 4 29 **A**7 5 28 A13 A6 6 27 **A**8 26 A9 A5 7 32-pin SOP 25 8 A11 **A**4 A3 9 24 OE# 23 A10 A2 10 **A**1 22 CS1# 11 21 DQ7 A0 12 DQ0 13 20 DQ6 DQ1 19 DQ5 14 DQ2 18 DQ4 15 GND 16 17 DQ3 A11 32 OE# 1 A9 31 2 A10 **A**8 CS1# 3 30 A13 4 29 DQ7 WE# 5 28 DQ6 CS2 27 DQ5 6 A15 26 DQ4 32-pin sTSOP Vcc 8 25 DQ3 NC 24 GND 9 A16 10 23 DQ2 A14 22 DQ1 11 A12 12 21 DQ0 20 **A**7 13 A0 A6 14 19 **A1** A5 15 18 A2 **A**4 16 17 A3 A11 32 OE# 1 A9 2 31 A10 **A**8 3 30 CS1# A13 DQ7 4 29 WE# 5 28 DQ6 CS2 6 27 DQ5 A15 7 26 DQ4 32-pin TSOP Vcc 8 25 DQ3 NC 9 24 GND A16 10 23 DQ2 A14 11 22 DQ1 A12 21 12 DQ0 **A**7 13 20 A0 **A**6 14 19 **A**1 A5 15 18 A2 **A**4 16 17 **A**3



Pin Description

Pin name	Function	
Vcc	Power supply	
Vss	Ground	
A0 to A16	Address input	
DQ0 to DQ7	Data input/output	
CS1#	Chip select 1	
CS2	Chip select 2	
WE#	Write enable	
OE#	Output enable	
NC	Non connection	

Block Diagram



Operation Table

CS1#	CS2	WE#	OE#	DQ0~7	Operation
Х	L	Х	Х	High-Z	Stand-by
Н	Х	Х	Х	High-Z	Stand-by
L	Н	L	Х	Din	Write
L	Н	Н	L	Dout	Read
L	Н	Н	Н	High-Z	Output disable

Note 1. H: V_{IH} L: V_{IL} X: V_{IH} or V_{IL}

Absolute Maximum

Parameter	Symbol	Va	lue	unit		
Power supply voltage relative to Vss	Vcc	-0.3	to +7	V		
Terminal voltage on any pin relative to Vss	VT	-0.3 ^{*1} to '	-0.3 ^{*1} to Vcc+0.3 ^{*2}			
Power dissipation	PT	0.7		W		
Operation temperature	Topr ^{*3}	R Ver.	0 to +70	ŝ		
Operation temperature	ropr	l Ver.	-40 to +85	°C		
Storage temperature range	Tstg	-65 to 150		°C		
Starage temperature range under biss	Tbias ^{*3}	R Ver.	0 to +70	0°		
Storage temperature range under bias	TDIAS	I Ver.	-40 to +85			

Note 1. -3.0V for pulse ≤ 30 ns (full width at half maximum)

2. Maximum voltage is +7V.

3. Ambient temperature range depends on R/I-version. Please see table on page 1.



DC Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note	
Supply voltage		Vcc	4.5	5.0	5.5	V	
		Vss	0	0	0	V	
Input high voltage		V _{IH}	2.2	-	Vcc+0.3	V	
Input low voltage		V _{IL}	-0.3	-	0.8	V	1
Ambient temperature range	R Ver.		0	-	+70	°C	2
Ambient temperature range	I Ver.	Та	-40	-	+85	°C	2

Note 1. -3.0V for pulse ≤ 30 ns (full width at half maximum)

2. Ambient temperature range depends on R/I-version. Please see table on page 1.

DC Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit		Test conditions	
Input leakage current	I _{LI}	-	-	1	μA	Vin = Vss	to Vcc	
Output leakage current	I _{LO}	-	-	1	μA	CS1# =V _{IH} or CS2 =V _{IL} or OE# =V _{IH} , VI/O =Vss to Vcc		
Average operating current	I _{CC1}	-	25	35	mA		, duty =100%, II/O = 0mA , CS2 =V _{IH} , Others = V _{IH} /V _{IL}	
	I _{CC2}	-	2	5	mA	Cycle =1 μ s, duty =100%, II/O = 0mA CS1# ≤ 0.2V, CS2 ≥ Vcc-0.2V, V _{IH} ≥ Vcc-0.2V, V _{IL} ≤ 0.2V		
Standby current	I _{SB}	-	-	3	mA	"CS2 =V _{IL} " or "CS2 = V _{IH} and CS1# =V _{IH} ", Others = Vss to Vcc		
Standby current		-	0.6 ^{*1}	2	μA	~+25°C	Vin = Vss to Vcc	
		-	-	3	μA	~+40°C	(1) CS2 \leq 0.2 or	
	I _{SB1}	-	-	8	μA	~+70°C	- (2) CS1# ≥ Vcc-0.2V, CS2 ≥ Vcc-0.2V	
		-	-	10	μA	~+85°C		
Output high voltage	Vон	2.4	-	-	V	I _{он} = -1mA	Ι	
	V _{OH2}	Vcc - 0.5	-	-	V	I _{OH} = -0.1n	nA	
Output low voltage	V _{OL}	-	-	0.4	V	I _{OL} = 2mA		

Note 1. Typical parameter indicates the value for the center of distribution at 5.0V (Ta= 25°C), and not 100% tested.

Capacitance

	(Vcc =	4.5V ~	5.5V, f	= 1MHz	z, Ta =	0 ~ +70°C / -40	~ +85°C ^{*2})
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions	Note
Input capacitance	C in	-	-	8	pF	Vin =0V	1
Input / output capacitance	C _{I/O}	-	-	10	pF	VI/O =0V	1

Note 1. This parameter is sampled and not 100% tested.

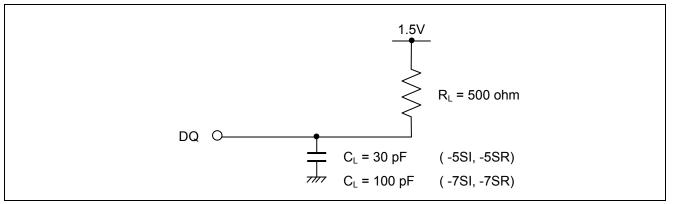
2. Ambient temperature range depends on R/I-version. Please see table on page 1.



AC Characteristics

Test Conditions (Vcc = $4.5V \sim 5.5V$, Ta = $0 \sim +70^{\circ}C / -40 \sim +85^{\circ}C^{*1}$)

- Input pulse levels: VIL = 0.6V, VIH = 2.4V
- Input rise and fall time: 5ns
- Input and output timing reference level: 1.5V
- Output load: See figures (Including scope and jig)



Note 1. Ambient temperature range depends on R/I-version. Please see table on page 1.



Read Cycle

Parameter	Symbol	R1LP010)8E**-5**	R1LP010)8E**-7**	Unit	Note
Parameter	Symbol	Min.	Max.	Min.	Max.	Unit	note
Read cycle time	t _{RC}	55	-	70	-	ns	
Address access time	t _{AA}	-	55	-	70	ns	
Chin coloct concept time	t _{ACS1}	-	55	-	70	ns	
Chip select access time	t _{ACS2}	-	55	-	70	ns	
Output enable to output valid	t _{OE}	-	30	-	35	ns	
Output hold from address change	t _{он}	5	-	10	-	ns	
Chin coloct to output in low 7	t _{CLZ1}	5	-	10	-	ns	2,3
Chip select to output in low-Z	t _{CLZ2}	5	-	10	-	ns	2,3
Output enable to output in low-Z	tolz	5	-	5	-	ns	2,3
Chin decolorities output in high 7	t _{CHZ1}	0	20	0	25	ns	1,2,3
Chip deselect to output in high-Z	t _{CHZ2}	0	20	0	25	ns	1,2,3
Output disable to output in high-Z	t _{онz}	0	20	0	25	ns	1,2,3

Write Cycle

Parameter	Symbol	R1LP01)8E**-5**	R1LP010)8E**-7**	Unit	Note
Parameter	Symbol	Min.	Max.	Min.	Max.	Unit	Note
Write cycle time	t _{wc}	55	-	70	-	ns	
Address valid to end of write	t _{AW}	50	-	55	-	ns	
Chip select to end of write	t _{CW}	50	-	55	-	ns	5
Write pulse width	t _{WP}	45	-	50	-	ns	4
Address setup time	t _{AS}	0	-	0	-	ns	6
Write recovery time	t _{WR}	0	-	0	-	ns	7
Data to write time overlap	t _{DW}	25	-	30	-	ns	
Data hold from write time	t _{DH}	0	-	0	-	ns	
Output enable from end of write	tow	5	-	5	-	ns	2
Output disable to output in high-Z	t _{OHZ}	0	20	0	25	ns	1,2
Write to output in high-Z	t _{wHz}	0	20	0	25	ns	1,2

Note 1. t_{CHZ}, t_{OHZ} and t_{WHZ} are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.

- 2. This parameter is sampled and not 100% tested.
- 3. At any given temperature and voltage condition, t_{HZ} max is less than t_{LZ} min both for a given device and from device to device.

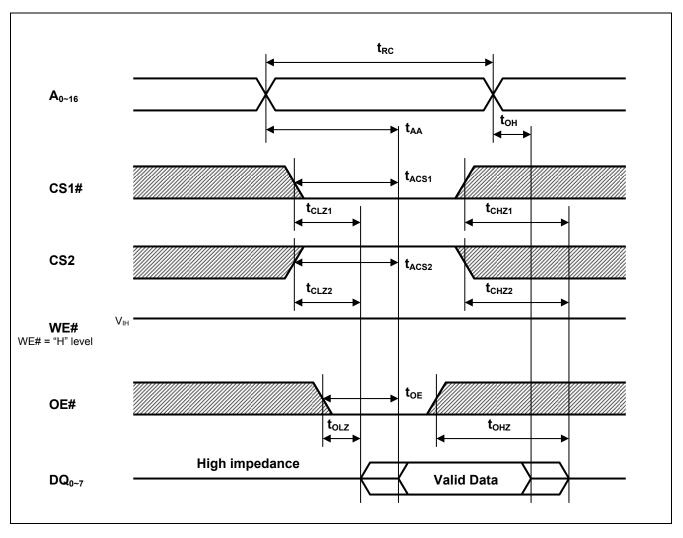
4. A write occurs during the overlap of a low CS1#, a high CS2, a low WE#. A write begins at the latest transition among CS1# going low, CS2 going high and WE# going low. A write ends at the earliest transition among CS1# going high, CS2 going low and WE# going high. t_{WP} is measured from the beginning of write to the end of write.

- 5. t_{CW} is measured from the later of CS1# going low or CS2 going high to end of write.
- 6. t_{AS} is measured the address valid to the beginning of write.
- 7. t_{WR} is measured from the earliest of CS1# or WE# going high or CS2 going low to the end of write cycle.
- 8. Don't apply inverted phase signal externally when DQ pin is output mode.



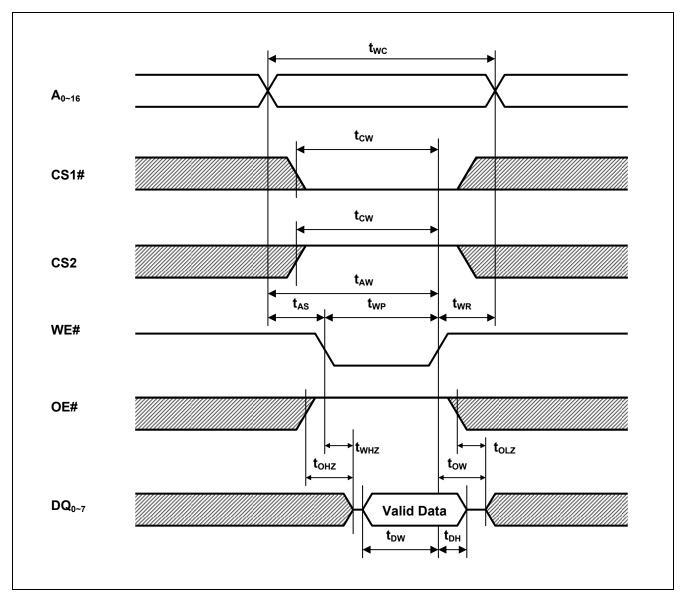
Timing Waveforms

Read Cycle



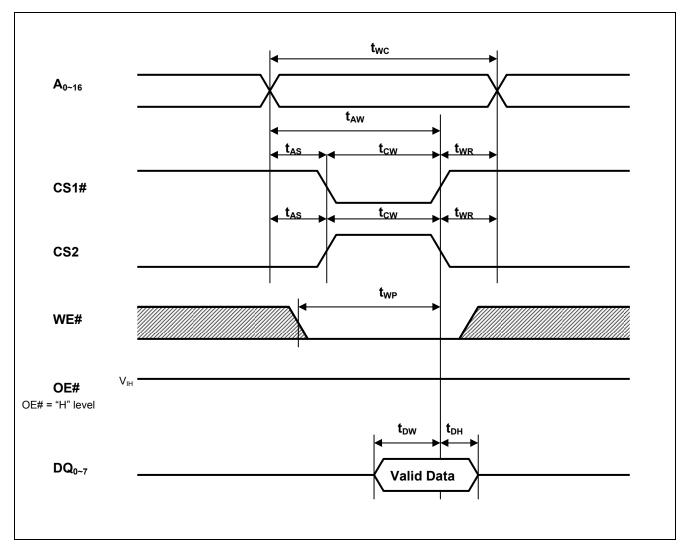


Write Cycle (1) (WE# CLOCK)





Write Cycle (2) (CS1#, CS2 CLOCK)





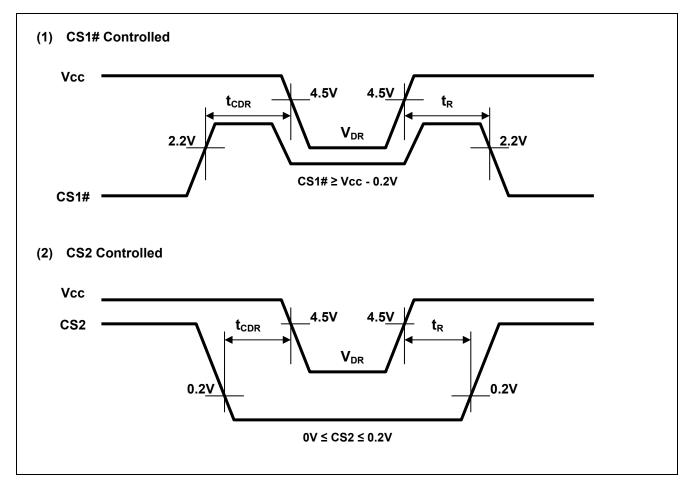
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions ^{*2}		
V _{cc} for data retention	V _{DR}	2.0	-	5.5	V	$Vin \ge 0V$ (1) $0V \le CS2 \le 0.2V$ or (2) $CS1\# \ge Vcc-0.2V$, $CS2 \ge Vcc-0.2V$		
		-	0.6 ^{*1}	2	μA	~+25°C	Vcc=3.0V, Vin ≥ 0V	
Data retention current	I _{CCDR}	-	-	3	μA	~+40°C	(1) $0V \le CS2 \le 0.2V$ or	
Data retention current		-	-	8	μA	~+70°C	(2) CS1# ≥ Vcc-0.2V, CS2 ≥ Vcc-0.2V	
		-	-	10	μA	~+85°C		
Chip deselect time to data retention	t _{CDR}	0	-	-	ns	See roton	tion waveform	
Operation recovery time	t _R	5	-	-	ms	See retention waveform.		

Low Vcc Data Retention Characteristics

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

CS2 controls address buffer, WE# buffer, CS1# buffer, OE# buffer and Din buffer. If CS2 controls data retention mode, Vin levels (address, WE#, CS1#, OE#, DQ) can be in the high impedance state.
 If CS1# controls data retention mode, CS2 must be CS2 ≥ Vcc-0.2V or 0V ≤ CS2 ≤ 0.2V. The other input levels (address, WE#, OE#, DQ) can be in the high impedance state.

Low Vcc Data Retention Timing Waveforms



Revision History	R1LP0108E Series Data Sheet
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			Description						
Rev.	Date	Page	Summary						
1.00	2013.6.21	-	First Edition issued						

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